

Applications

- IEEE802.11b DSSS WLAN
- IEEE802.11g,n OFDM WLAN
- Access Points, PCMCIA, PC cards

Features

- Dual Mode IEEE802.11b, IEEE802.11g, IEEE802.11n
- Integrated PA, TX Filter, SP3T switch
- Integrated Positive Slope Power Detector
- 20 dBm Output Power, 802.11b, 11 Mbps
- 18 dBm @ 3.0 % EVM, 802.11g, 3.3V
- Lead free, halogen free and RoHS compliant
- Small plated package, 3 mm x 3 mm x 0.6 mm, MSL 1

Product Description

The SE2614BT is a complete 802.11bgn WLAN RF front-end module providing all the functionality of the power amplifier, power detector, SP3T Switch and 50 ohm matching on all RF ports in an ultra compact form factor.

The SE2614BT is designed for ease of use, with all the critical matching and harmonic filtering integrated. The SE2614BT also includes a transmitter power detector with 20 dB of dynamic range and a digital enable control for transmitter power on/off control. The power ramp rise/fall time is 0.1 µs typical.

Ordering Information

Part No.	Package	Remark
SE2614BT	20 lead QFN	Samples
SE2614BT-R	20 lead QFN	Tape & Reel
SE2614BT-EK1	N/A	Evaluation kit

Functional Block Diagram

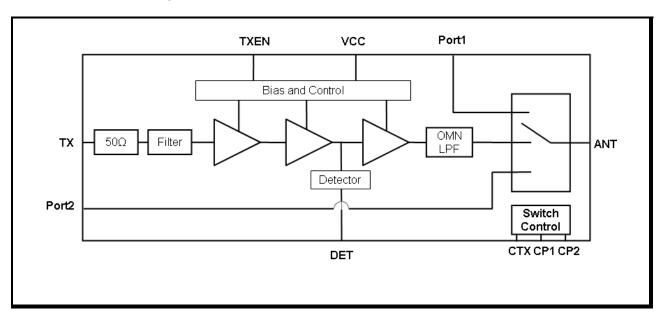


Figure 1: Functional Block Diagram



DATA SHEET

SE2614BT: 2.4 GHz High Efficiency Wireless LAN Front End

Preliminary

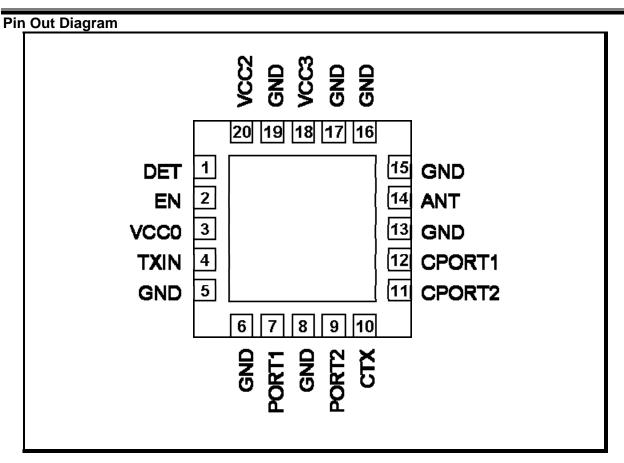


Figure 2: SE2614BT Pin Out (Top View Through Package)

Pin Out Description

Pin	Name	Description
1	DET	Power Detector output
2	EN	TX Enable
3	VCC0	Supply Voltage – Pre-driver & Driver
4	TXIN	TX input
5	GND	Ground
6	GND	Ground
7	PORT1	Port 1 – May be used for RX or BT
8	GND	Ground
9	PORT2	Port 2 – May be used for RX or BT
10	CTX	Switch Control Logic – TX path

Pin	Name	Description
11	CPORT2	Switch Control Logic – Port 2 path
12	CPORT1	Switch Control Logic – Port 1 path
13	GND	Ground
14	ANT	Antenna Output
15	GND	Ground
16	GND	Ground
17	GND	Ground
18	Vcc3	Supply Voltage Power Stage
19	GND	Ground
20	Vcc2	Supply Voltage



Absolute Maximum Ratings

These are stress ratings only. Exposure to stresses beyond these maximum ratings may cause permanent damage to, or affect the reliability of the device. Avoid operating the device outside the recommended operating conditions defined below. This device is ESD sensitive. Handling and assembly of this device should be at ESD protected workstations.

Symbol	Definition	Min.	Max.	Unit
VCC	Supply Voltage on VCC	-0.3	3.6	V
Vin	DC input on EN, CTX, CPORT1, CPORT2	-0.3	3.6	V
TX	RF Input Power.	-	12.0	dBm
TA	Operating Temperature Range	-40	85	°C
Тѕтс	Storage Temperature Range	-40	150	°C
ESD _{HBM}	JEDEC JESD22-A114 all pins to Ground	-	1	KV

Recommended Operating Conditions

Symbol	Parameter	Min.	Тур.	Max.	Unit
TA	Ambient temperature	-40	25	85	°C
VCC	VCC0, VCC2, VCC3, supply voltage	3.0	3.3	3.6	V

DC Electrical Characteristics

Conditions: VCC = EN = 3.3 V, T_A = 25 °C, as measured on Skyworks Solutions' SE2614BT-EK1 evaluation board, all unused ports terminated with 50 ohms, unless otherwise noted

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Icc-g	Total Supply Current	POUT = 18 dBm, 54 Mbps OFDM signal, 64QAM	1	160	-	mA
Ісс-в	Total Supply Current	P _{OUT} = 20 dBm, 11 Mbps CCK signal, BT = 0.45	-	190	-	mA
Icq	Total Supply Current	No RF	-	90	-	mA
Icntl	Control Line Current	CTX, CPORT2, CPORT1 = 3.3V		1	10	μΑ
Icc_off	Total Supply Current	No RF Applied, EN = CTX = CPORT1 = CPORT2 = 0 V	-	1	10	μΑ



PA Logic Characteristics

Conditions: VCC = EN = 3.3 V, T_A = 25 °C, as measured on Skyworks Solutions' SE2614BT-EK1 evaluation board, all unused ports terminated with 50 ohms, unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
VENH	Logic High Voltage (Module On)	-	1.6	3.3	3.6	V
VENL	Logic Low Voltage (Module Off)	-	0	-	0.4	V
lenh	Input Current Logic High Voltage	-	-	330	400*	μΑ
lenl	Input Current Logic Low Voltage	-	-	2	10	μΑ

^{*}due to on chip pulldown resistor

Switch Logic Characteristics

Conditions: VCC = EN = 3.3 V, T_A = 25 °C, as measured on Skyworks Solutions' SE2614BT-EK1 evaluation board (de-embedded to device), all unused ports terminated with 50 ohms, unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Vctl_on	Control Voltage (On State)	-	1.6	3.3	3.6	V
VCTL_OFF	Control Voltage (OFF State)	-	0.0	-	0.4	V
T _{switch}	T/R Switching Speed	VCTL_OFF -> VCTL_ON VCTL_ON -> VCTL_OFF		200	-	nSec
Ссть	Control Input Capacitance	-	-	-	1	pF

Switch Control Logic Table

Allowed Switch Logic						
CPORT1 CPORT2 CTX PORT1 – ANT PORT2 – ANT TX-ANT						
ON	OFF	OFF	ON	OFF	OFF	
OFF	ON	OFF	OFF	ON	OFF	
OFF	OFF	ON	OFF	OFF	ON	
All Other States Not Supported						



AC Electrical Characteristics

802.11g/n Transmit Characteristics

Conditions: VCC = EN = CTX = 3.3 V, CPORT1 = CPORT2 = 0 V, $T_A = 25 ^{\circ}C$, as measured on Skyworks Solutions' SE2614BT-EK1 evaluation board, all unused ports terminated with 50 ohms, unless otherwise noted.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit	
Fin	Frequency Range	-	2400	-	2500	MHz	
POUT	Output Power	54 Mbps OFDM signal, 64 QAM, 3% EVM	-	18	-	dBm	
ACPR, IEEE Mask	Spectral Mask	Pout = 20 dBm, 11 Mbps CCK, BT = 0.45 11 - 22 MHz 22 - 33 MHz	-	-35 -55	-	dBc	
P1 _{dB}	P1dB	-	-	25	-	dBm	
S ₂₁	Small Signal Gain	-	-	30	-	dB	
Δ\$21_Τ	Small Signal Gain vs Temp	Measured at single freq from -40°C to 85°C	-1.5		+1.5	dB	
ΔS21	Small Signal Gain Variation	Gain variation over single 40MHz channel	-	0.5	-	dB	
		Gain Variation over band	-	1.1	-		
S ₂₁ 3.2	Gain @ limit 3.2Ghz	3206 to 3312 MHz	-	10	15	dB	
2f	Harmonics	Роит = 20 dBm, 1 Mbps,	-	-50	-45	dBm/MHz	
3f	Hamionics	DSSS	-	-50	-45	dBm/MHz	
tdr, tdf	Delay and rise/fall Time	50 % of Ven edge and 90/10 % of final output power level	-	0.2	-	μs	
S ₁₁	Input Return Loss	-	-	10	-	dB	
STAB	Stability	CW, Pout = 20 dBm 0.1 GHz - 20 GHz Load VSWR = 6:1	All non-harmonically related outputs less than -42 dBm/MHz				
RU	Ruggedness	P _{IN} = 12dBm, Load VSWR = 6:1	No perma	nent damaç	ge		



Receive and BT Characteristics

Conditions: VCC = 3.3 V, EN = CTX = 0 V, T_A = 25 °C, as measured on Skyworks Solutions' SE2614BT-EK1 evaluation board, all unused ports terminated with 50 ohms, unless otherwise noted.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
Fоuт	Frequency Range	-	2400	-	2500	MHz
RXIL	Insertion Loss	CPORT1 = 0 V and CPORT2 = 3.3 V or CPORT1 = 3.3 V and CPORT2 = 0 V	-	1.2	-	dB
RX _{RL}	Return Loss	PORT1 or PORT2	15	20	-	dB
BTıL	Insertion Loss	-	-	1.2	-	
BT _{RL}	Return Loss	PORT1 or PORT2	15	20	-	dB
T _{on/off}	T/R on/off switching speed	Switching speed between T/R modes. V _{cc0} =3.3V.		200	250	nSec
ANTR _{ISOL}	Isolation between ANT and PORT1/PORT2	Difference in signal level on PORT1 or PORT2 when transmitting from TX. CTX = 3.3V, CPORT1 = CPORT2 = 0V PORT1 and PORT2 terminated in 50ohm.	-	25	-	dB



Power Detector Characteristics

Conditions: VCC = EN = CTX = 3.3 V, CPORT1 = CPORT2 = 0 V, T_A = 25 °C, as measured on Skyworks Solutions' SE2614BT-EK1 evaluation board, unless otherwise noted.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
Fouт	Frequency Range	-	2400	-	2500	MHz
PDR	Power detect range, CW	Measured at ANT	0	-	21	dBm
PDV _{NoRF}	Output Voltage, Pout = No RF	Measured into 26KΩ	-	0.35	-	V
PDV _{P18}	Output Voltage, Pout = 18 dBm CW	Measured into 26KΩ	-	0.68	-	V
PDV _{P21}	Output Voltage, Pout = 22 dBm CW	Measured into 26KΩ	-	0.83	-	٧
Zout	Detector output impedance			1		ΚΩ
LPF-3dB	Power detect low pass filter -3dB corner frequency	PDCLOAD = High Z (1MΩ)	-	500	-	KHz

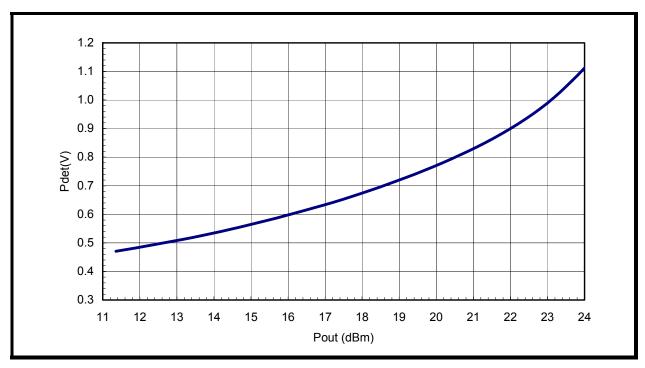


Figure 3: SE2614BT Power Detector Characteristics



Package Diagram

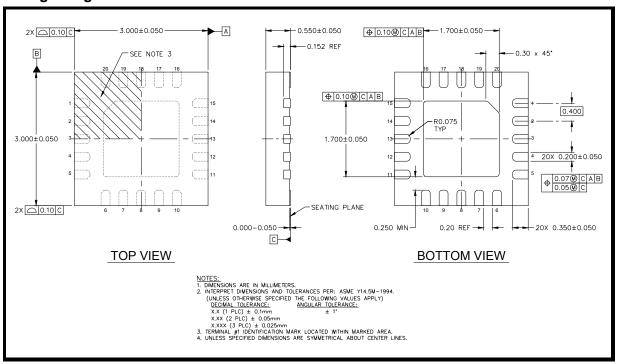


Figure 4: SE2614BT Package Outline Drawing



Recommended Land and Solder Patterns

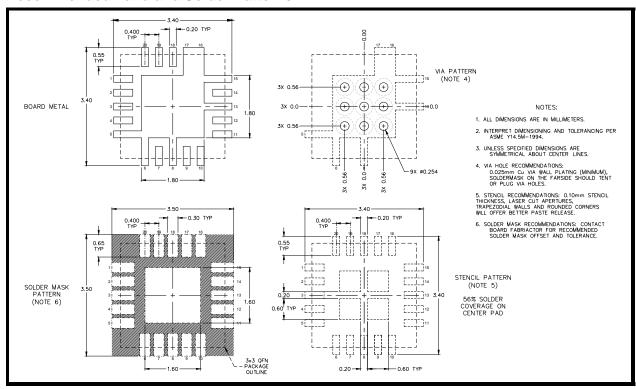


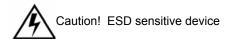
Figure 5: Recommended Land and Solder Patterns



Package Handling Information

Because of its sensitivity to moisture absorption, instructions on the shipping container label must be followed regarding exposure to moisture after the container seal is broken, otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly. The SE2614BT is capable of withstanding a Pb free solder reflow. Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. If the part is manually attached, precaution should be taken to insure that the device is not subjected to temperatures above its rated peak temperature for an extended period of time. For details on both attachment techniques, precautions, and handling procedures recommended, please refer to:

- "Quad Flat No-Lead Module Solder Reflow & Rework Information", Document Number QAD-00045
- "Handling, Packing, Shipping and Use of Moisture Sensitive QFN", Document Number QAD-00044



Branding Information

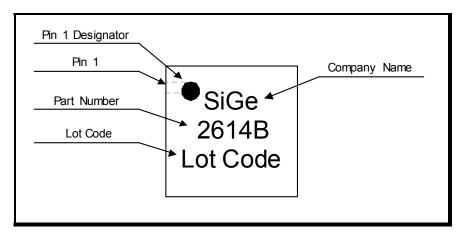


Figure 6: SE2614BT Branding Information

Tape and Reel Information

Parameter	Value	
Devices Per Reel	3000	
Reel Diameter	13 inches	
Tape Width	12 millimeters	
pin 1 corner		
5 0,0000		

Figure 7: SE2614BT-R Tape and Reel Information



Document Change History

Revision	Date	Notes
1.0	January 17, 2011	Created
1.1	February 3, 2011	Updated MSL rating and landing pattern.
1.2	June 15, 2011	Updated ESD rating to 1KV
1.3	April 3, 2012	Updated with Skyworks logo and disclaimer statement

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